



SC1565F

SILICON CARBIDE SCHOTTKY DIODE
Reverse Voltage-650 Volts
Forward Current -15.0Amperes

Features

- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Positive Temperature Coefficient on V_F
- Temperature-independent Switching
- 175°C Operating Junction Temperature

Benefits

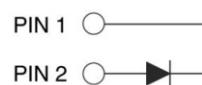
- Replace Bipolar with Unipolar Device
- Reduction of Heat Sink Size
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses

Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor drive, PV Inverter, Wind Power Station

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V_{RRM}	=	650	V
$I_F(T_c \leq 42^\circ C)$	=	18	A
Q_c	=	36	nC

Maximum Ratings

(Ratings at 25 °C ambient temperature unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	650	V	$T_c = 25^\circ C$	
V_{RSM}	Surge Peak Reverse Voltage	650	V	$T_c = 25^\circ C$	
V_R	DC Blocking Voltage	650	V	$T_c = 25^\circ C$	
I_F	Forward Current	18 15	A	$T_c \leq 42^\circ C$ $T_c \leq 65^\circ C$	
I_{FSM}	Non-Repetitive Forward Surge Current	100	A	$T_c = 25^\circ C, t_p = 8.3ms$, Half Sine Wave	
P_{tot}	Power Dissipation	47	W	$T_c = 25^\circ C$	Fig. 3
T_J, T_{STG}	Operating Junction and Storage Temperature	-55 to 175	°C		

Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.4	1.65	V	$I_F = 15A, T_J = 25^\circ C$	Fig. 1
		1.7	2.3		$I_F = 15A, T_J = 175^\circ C$	
I_R	Reverse Current	2	20	μA	$V_R = 650V, T_J = 25^\circ C$	Fig. 2
		10	200		$V_R = 650V, T_J = 175^\circ C$	
C	Total Capacitance	865	/	pF	$V_R = 0V, T_J = 25^\circ C, f = 1MHz$	Fig. 5
		88	/		$V_R = 200V, T_J = 25^\circ C, f = 1MHz$	
		72	/		$V_R = 400V, T_J = 25^\circ C, f = 1MHz$	
Q_C	Total Capacitive Charge	36	/	nC	$V_R = 650V, I_F = 15A$ $di/dt = 200A/\mu s, T_J = 25^\circ C$	Fig. 4

Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	3.2	°C/W	Fig. 6
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	80	°C/W	
T_{sold}	Soldering Temperature	260	°C	

Typical Performance

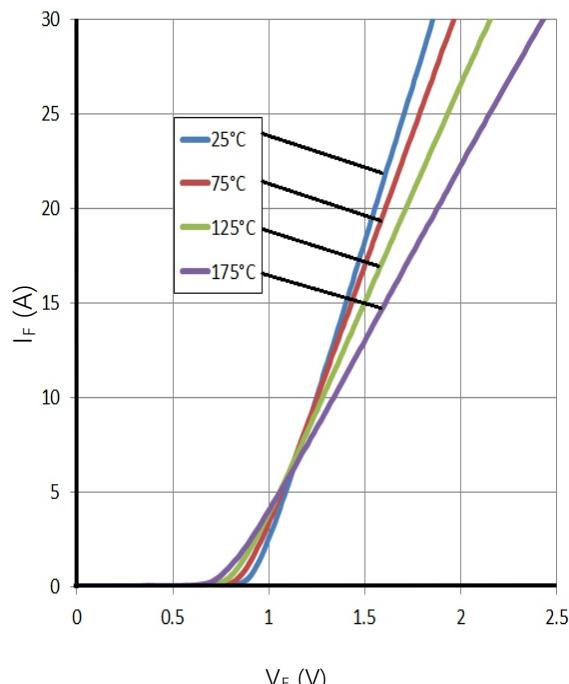


Figure 1. Forward Characteristics

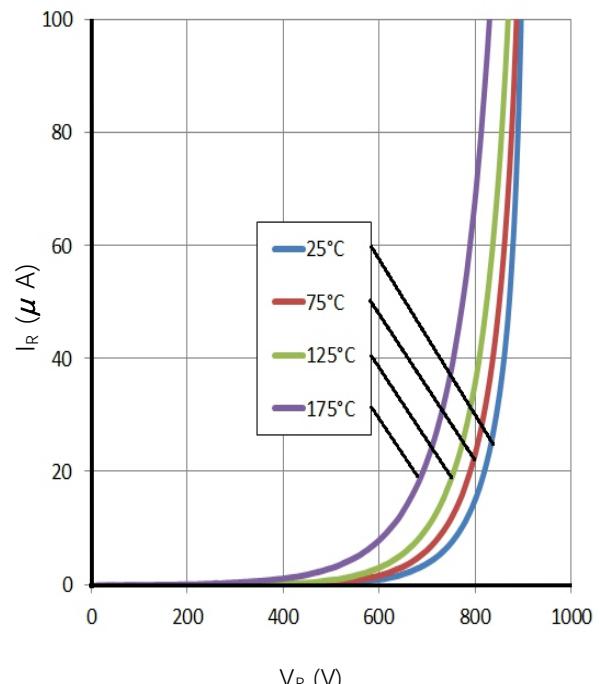


Figure 2. Reverse Characteristics

Typical Performance

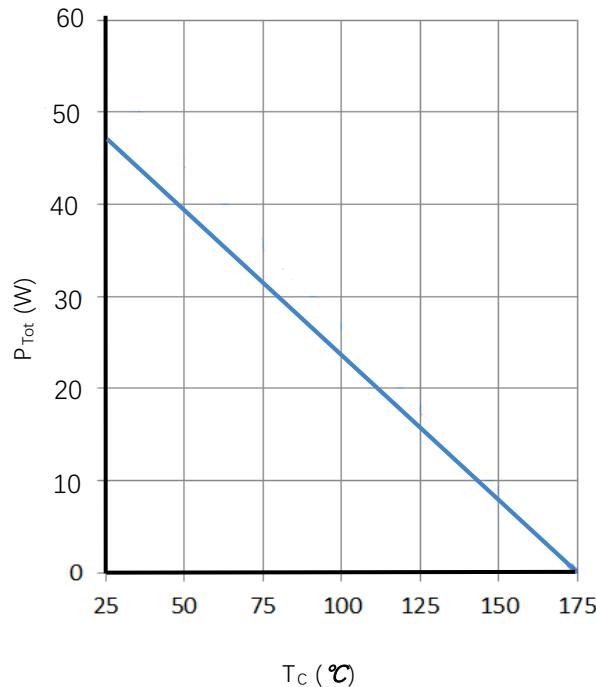


Figure 3. Power Derating

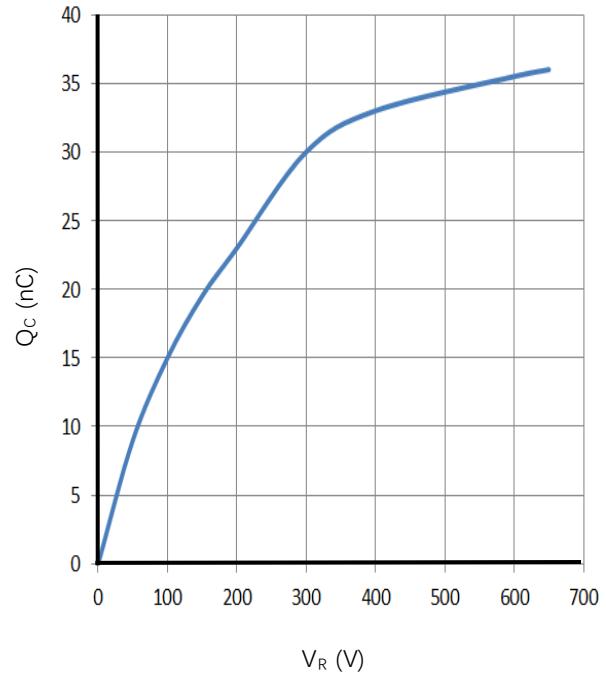


Figure 4. Total Capacitive Charge vs. Reverse Voltage

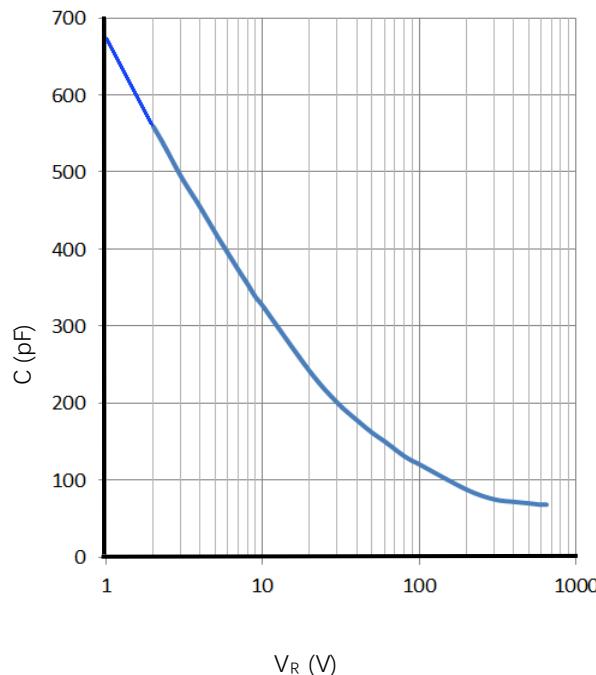


Figure 5. Total Capacitance vs. Reverse Voltage

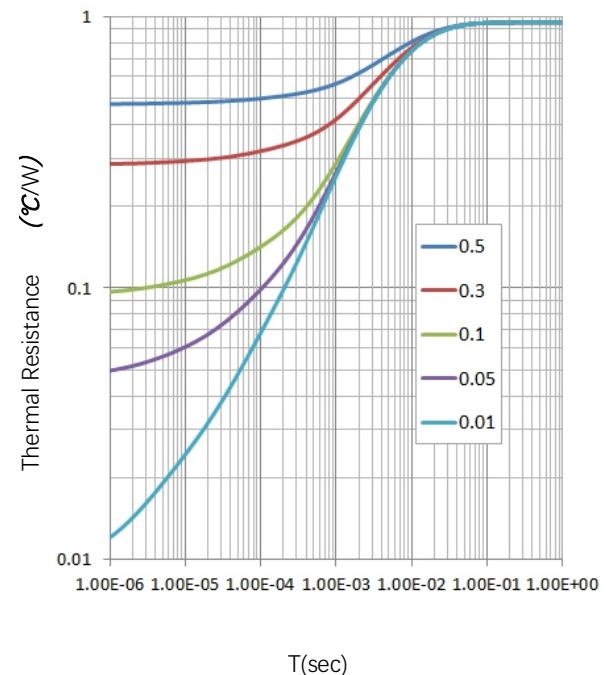
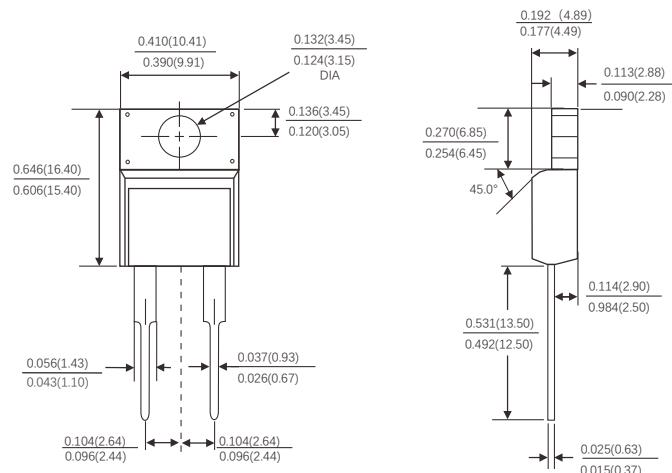


Figure 6. Transient Thermal Impedance

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Dimensions in inches and (millimeters)

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